

Purolite™ CriticalResin™ NRW1160

聚苯乙烯 凝胶, 强酸阳离子树脂, 氢型, 均颗粒, 核级

主要应用

- 二回路抛光
- 混床上的额外层

产品优势

- 高工作交换容量

包装样式

- 1CF 纸盒
- 5 CF 纤维板桶

典型物理和化学参数

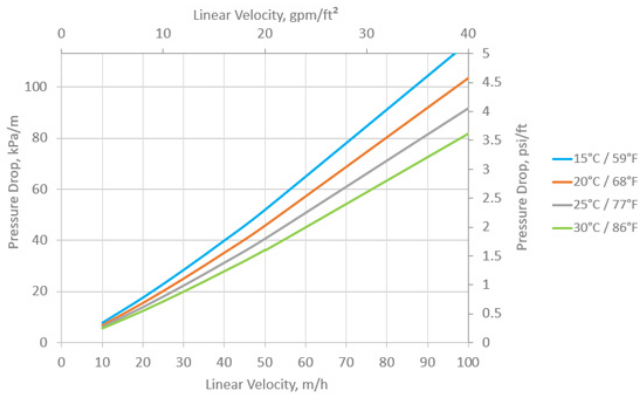
聚合物骨架	凝胶型聚苯乙烯二乙烯苯交联
外观	球状颗粒
官能团	磺酸
离子型态	H- 型
全交换容量 (最小)	2.5 eq/L (54.6 Kgr/ft ³) (H- 型)
含水量	32 - 41 % (H- 型)
平均直径	625 ± 75 μm
均一系数 (最大)	1.2
转型率 (最低)	99.9 % (H- 型)
杂质 铁 (最大)	50 ppm
杂质 钠 (最大)	40 ppm
杂质 重金属 (最大)	40 ppm
比重	1.23
包装密度 (大约)	780 - 820 g/L (48.8 - 51.2 lb/ft ³)
温度限制	120 °C (248.0 °F)

水力学特性

压降

离子交换树脂的压降取决于粒度分布、床层高度、树脂颗粒间空隙体积，以及物料的流速和粘度。任何对这些参数的影响-比如被树脂床层截住的颗粒物、对树脂床层的异常压缩、床层的不规则分布-都会对压降产生不利影响，造成压头损失。针对不同的物料质量、应用环境和系统设计，流速可能处于10 – 40 BV/h范围内变化。

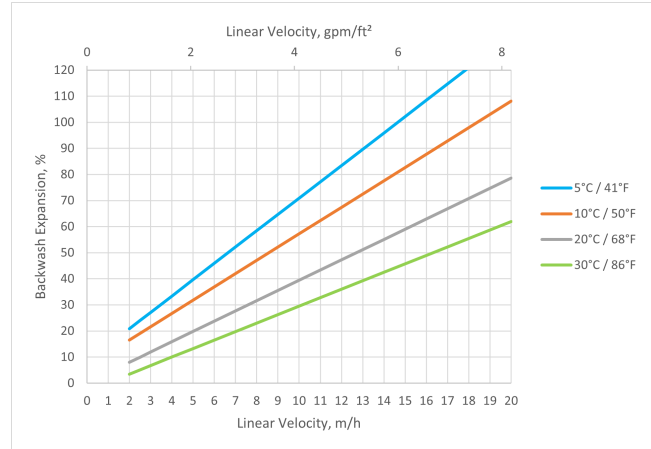
床层压降



反洗

在自下而上反洗过程中，应控制反洗膨胀率在50%到70%之间，至少保持10到15分钟。该操作除去（运行过程中截留的物料中的）颗粒物，清除气泡，并重新规整树脂颗粒，确保最小的流动阻力。第一次投入前，大约30分钟的充分反洗，通常就足以对树脂床层进行适当的规整。值得注意的是，相同流速下反洗膨胀率随温度降低而升高。必须注意，应避免将树脂床层反洗膨胀过甚而导致树脂从顶部流失。

树脂床反洗膨胀率



Ecolab is a global developer, manufacturer, and supplier of Purolite™ Resins including ion exchange, catalyst adsorbent and advanced polymers that make the world cleaner and healthier.

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